

## CLAIMS:

1. A method of producing a model or tool comprising  
(a) building an assembly of substrates by assembling and adhering a  
5 substrate to another substrate with a layer of adhesive paste, preferably  
building a stack assembly of substrates adhered with several intermediate  
layers of adhesive paste,  
(b) optionally machining the assembly of substrates,  
(c) covering the outer surface of the assembly of substrates with a continuous  
10 layer of curable paste preferably machine dispensed, and  
(d) optionally after cure, machining to the final structure, preferably  
according to a computer design, wherein the composition of the curable paste  
of step (c) is the same as the composition of at least one of the adhesive paste  
layers of step (a).  
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2. The method as claimed in claim 1, comprising machine mixing at least 2  
separate components to form the curable and adhesive paste.
3. The method as claimed in any preceding claim, wherein the curable and  
20 adhesive paste is thixotropic and has non-slump properties.
4. The method as claimed in any preceding claim wherein the curable and  
adhesive paste has a dynamic viscosity equal to or less than 10,000 mPa s  
measured at 25°C.  
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5. The method as claimed in any preceding claim, wherein the curable paste is  
an epoxy paste obtained by mixing an epoxy component and a hardener  
component.
- 30 6. The method as claimed in any preceding claim, wherein the curable paste  
comprises an epoxy component containing a curable epoxy resin and a

hardener component containing a latent or semi-latent hardener.

7. A method of producing a model or tool comprising the sequential steps of:  
mixing 2 components to form a curable paste, a first component containing a  
curable resin, preferably a curable epoxy resin, and a second component  
containing a hardener system, which contains a latent or semi latent  
hardener,  
applying the paste on the outer surface of a substructure in the form of a  
continuous layer, curing the continuous layer of paste, machining said cured  
layer to the desired contour.
8. The method as claimed in any preceding claim, wherein the curable paste  
comprises:  
(1) an epoxy resin;  
(2) a thixotropic agent, preferably in an amount sufficient to induce  
thixotropic properties; and  
(3) a hardener system comprising (a) at least one polyethyleneimine, (b) at  
least one other amine having at least two amino hydrogen groups and (c) at  
least one other epoxy curative having latent reactivity (requiring heat to fully  
react), the combined amounts of (a),(b) and (c) being sufficient to effect cure  
of the epoxy resin.
9. The method of claim 6 or 7, wherein the latent or semi-latent hardener (3)  
comprises any slow reacting epoxy curative which cures slowly or not at all  
at normal ambient temperature requiring heat to cause full reaction and  
preferably contains Diethyl toluene diamine, Dicyandiamide, Diphenyl  
diamino sulphone, Boron complexes (eg amine-boron, or alkoxide-boron  
complexes), and/or imidazoles.
10. The method as claimed in any preceding claim, wherein the cured paste as a  
Heat Deflection Temperature above 100C, preferably above 140C, more

preferably above 150C .

11. The method as claimed in any preceding claim, wherein the final cured  
model or tool is machined to form a tool for production of laminated  
5 composites, preferably containing non-halogenated fire retardants.

12. A method of producing a model or tool comprising:

- (a) building an assembly of substrates by assembling and adhering at least  
one substrate to another substrate with a layer of adhesive paste,  
10 (b) covering the outer surface of the assembly of substrates with a continuous  
layer of curable paste, preferably machine dispensed  
wherein the composition of the curable paste of step (b) is the same as the  
composition of at least one of the adhesive paste layers of step (a) and the  
composition of this curable paste comprises epoxy resin, amine hardener and  
15 a polyethyleneimine compound.

13. A curable composition comprising:

- (1) an epoxy resin;  
(2) a thixotropic agent preferably present in an amount sufficient to induce  
20 thixotropic properties; and  
(3) a hardener system comprising (a) at least one polyethyleneimine, (b) at  
least one other amine having at least two amino hydrogen groups and (c) at  
least one other epoxy curative having latent reactivity (requiring heat to fully  
react), the combined amounts of (a),(b) and (c) being sufficient to effect cure  
25 of the epoxy resin.